ABSTRACT OF THE DISCLOSURE

An active matrix substrate includes: electrode wires constituted by gate electrodes 2 and source electrodes 6 that are arranged in a lattice; an insulating protection film provided at least on the electrode wires so as to have openings 11a in predetermined areas on the source electrodes 6; and a metal layer stacked on the source electrodes 6 in the openings 11a. Since there is a metal layer stacked on the source electrodes 6, the source electrodes 6 can be readily increased in thickness and hence sufficiently reduced in resistance, by means of the metal layer. Thus, the electrode wires become thicker and more conducting. This way, it becomes possible to provide active matrix substrates and their methods of manufacturing that are suitably applicable to, for example, display devices and image-capturing devices.